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Patent Assignment Abstract of Title

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Total Assignments: 1

Inventors: ALAN G. WOOD, WARREN M. FARNWORTH

Title: PROCESS FOR PACKING A SEMICONDUCTOR DIE USING AND TESTING

Assignment: 1

Conveyance: ASSIGNMENT OF ASSIGNORS INTEREST (SEE DOCUMENT FOR DETAILS).

Assignors: FARNWORTH, WARREN M.

Exec Dt: 12/12/1995

<u>WOOD, ALAN G.</u>

Exec Dt: 12/12/1995

Assignee: MICRON TECHNOLOGY, INC.

LEGAL DEPARTMENT M/S 507 800 SOUTH FEDERAL WAY BOISE, IDAHO 83707

Correspondent: STEPHEN A. GRATTON

10275 GUMBARK PLACE SAN DIEGO, CA 92131

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